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FAIRCHILD SEMICONDUCTOR®

January 2013

FDN537N

Single N-Channel Power Trench® MOSFET

30 V, 6.5 A, 23 mΩ

Features

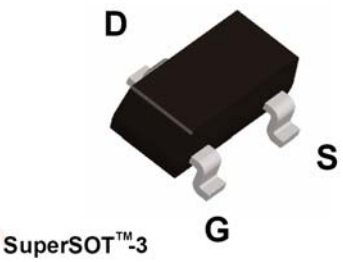
- Max $r_{DS(on)}$ = 23 mΩ at V_{GS} = 10 V, I_D = 6.5 A
- Max $r_{DS(on)}$ = 36 mΩ at V_{GS} = 4.5 V, I_D = 6.0 A
- High performance trench technology for extremely low $r_{DS(on)}$
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

General Description

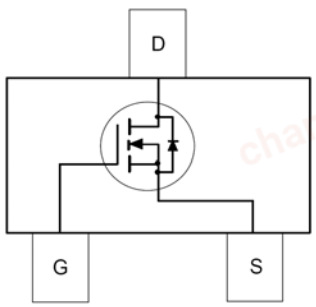
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench® process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Application

- Primary DC-DC Switch



SuperSOT™-3



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V_{DS}	Drain to Source Voltage			30	V
V_{GS}	Gate to Source Voltage		(Note 3)	±20	V
I_D	Drain Current -Continuous (Package limited)	T_C = 25 °C		8.0	A
	-Continuous	T_A = 25 °C	(Note 1a)	6.5	
	-Pulsed			25	
P_D	Power Dissipation		(Note 1a)	1.5	W
	Power Dissipation		(Note 1b)	0.6	
T_J, T_{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	80	°C/W
	Thermal Resistance, Junction to Ambient	(Note 1b)	180	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
537	FDN537N	SSOT-3	7 ”	8 mm	3000 units

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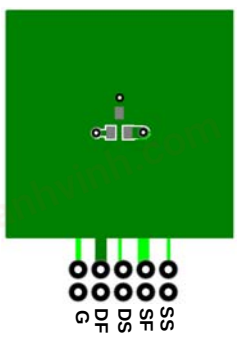
Electrical Characteristics T_J = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V_{GS} = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25 °C		18		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 24 V, V_{GS} = 0 V			1	μA
I_{GSS}	Gate to Source Leakage Current, Forward	V_{GS} = 20 V, V_{DS} = 0 V			100	nA
On Characteristics						
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA	1.2	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25 °C		-6		mV/°C
$r_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 6.5 A		19	23	mΩ
		V_{GS} = 4.5 V, I_D = 6.0 A		25	36	
		V_{GS} = 10 V, I_D = 6.5 A, T_J = 125 °C		25	30	
g_{FS}	Forward Transconductance	V_{DD} = 5 V, I_D = 6.5 A		24		S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz		360	465	pF
C_{oss}	Output Capacitance			143	180	pF
C_{rss}	Reverse Transfer Capacitance			22	35	pF
R_g	Gate Resistance			1.0		Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 15 V, I_D = 6.5 A, V_{GS} = 10 V, R_{GEN} = 6 Ω		5	10	ns
t_r	Rise Time			1	10	ns
$t_{d(off)}$	Turn-Off Delay Time			11	19	ns
t_f	Fall Time			1	10	ns
$Q_{g(TOT)}$	Total Gate Charge	V_{GS} = 0 V to 10 V, V_{DD} = 15 V, I_D = 6.5 A		6.0	8.4	nC
	Total Gate Charge	V_{GS} = 0 V to 4.5 V, V_{DD} = 15 V, I_D = 6.5 A		3.0	4.2	nC
Q_{gs}	Total Gate Charge	V_{DD} = 15 V, I_D = 6.5 A		1.2		nC
Q_{gd}	Gate to Drain “Miller” Charge	V_{DD} = 15 V, I_D = 6.5 A		1.1		nC
Drain-Source Diode Characteristics						
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_S = 6.5 A (Note 2)		0.86	1.2	V
t_{rr}	Reverse Recovery Time	I_F = 6.5 A, di/dt = 100 A/μs		14	22	ns
Q_{rr}	Reverse Recovery Charge			3	10	nC

NOTES:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 80 °C/W when mounted on a 1 in^2 pad of 2 oz copper



b) 180 °C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0 %.

3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

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Typical Characteristics T_J = 25 °C unless otherwise noted

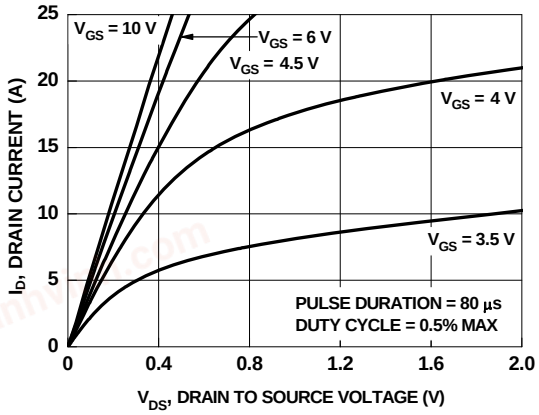

Figure 1. On Region Characteristics

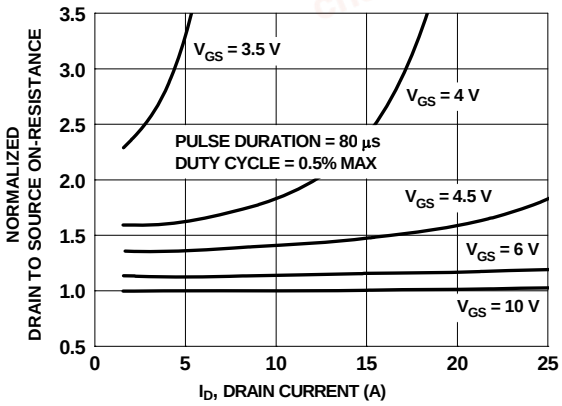

Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

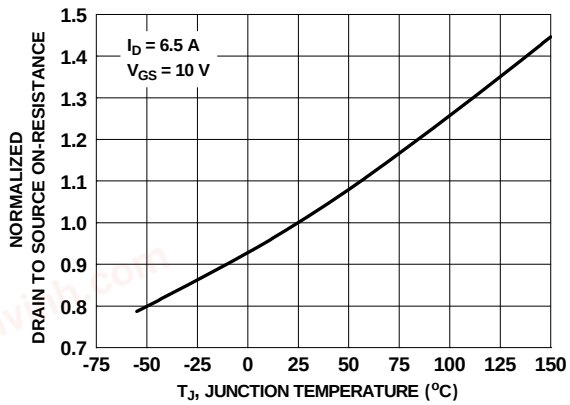

Figure 3. Normalized On Resistance vs Junction Temperature

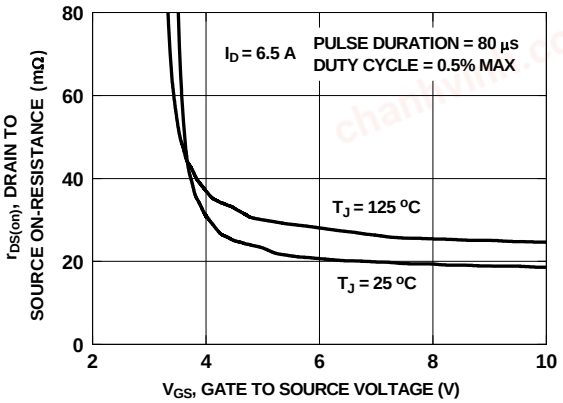

Figure 4. On-Resistance vs Gate to Source Voltage

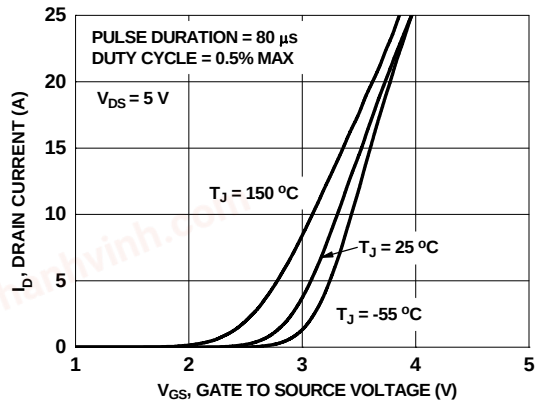

Figure 5. Transfer Characteristics

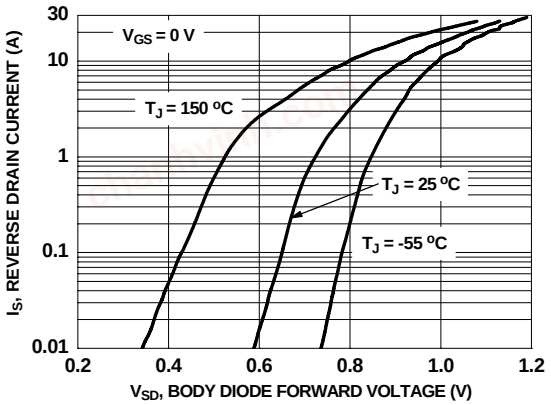

Figure 6. Source to Drain Diode Forward Voltage vs Source Current

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Typical Characteristics T_J = 25 °C unless otherwise noted

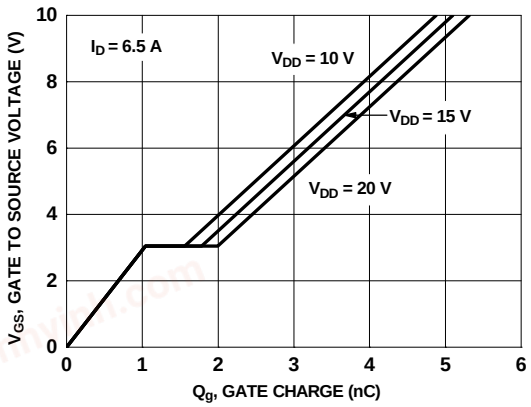

Figure 7. Gate Charge Characteristics

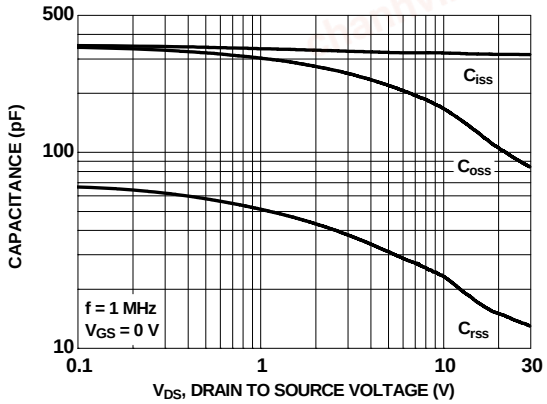

Figure 8. Capacitance vs Drain to Source Voltage

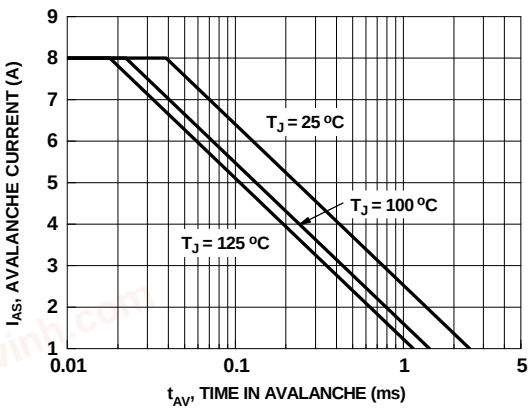

Figure 9. Unclamped Inductive Switching Capability

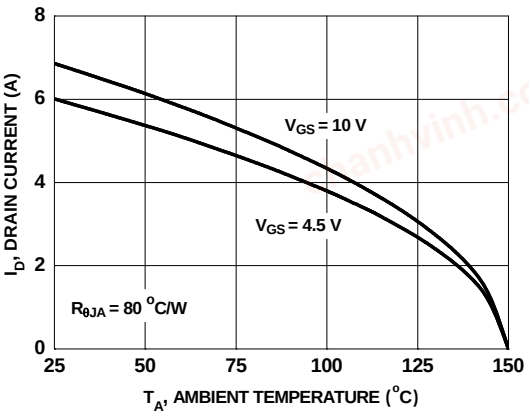

Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

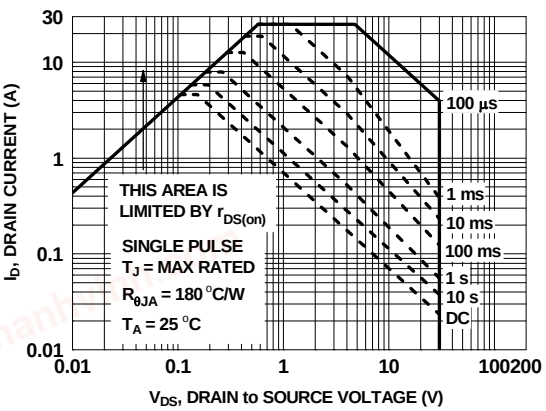

Figure 11. Forward Bias Safe Operating Area

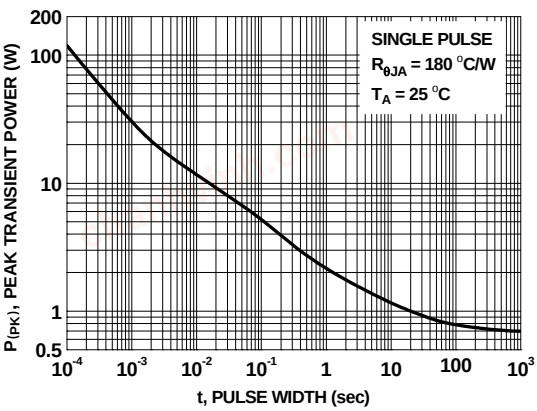

Figure 12. Single Pulse Maximum Power Dissipation

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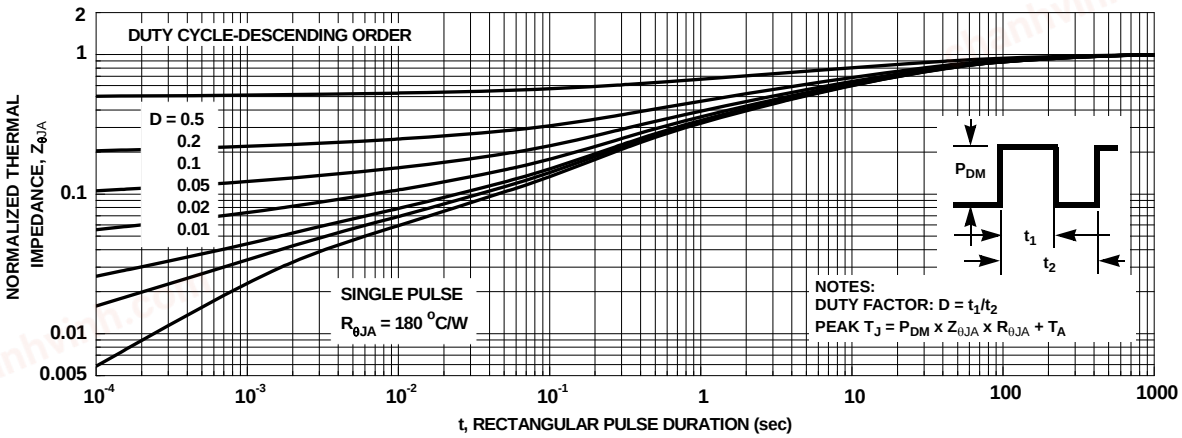

Figure 13. Junction-to-Ambient Transient Thermal Response Curve

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